



SDLS145A-APRIL 1985-REVISED JULY 2008

QUADRUPLE BUS TRANSCEIVERS

FEATURES

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- Two-Way Asynchronous Communication Between Data Buses
- PNP Inputs Reduce D-C Loading
- Hysteresis (Typically 400 mV) at Inputs Improves Noise Margin

SN54LS243.	J OR W PACKAGE
SN74LS243	D, N, OR NS PACKAGE
(1	TOP VIEW)

GAB 🗌	1	U 14	Vcc
NC	2	13] GBA
A1	3	12	□ NC
A2 🗌	4	11	B1
A3 🗌	5	10	_ B2
A4 🗌	6	9	_ B3
GND 🗌	7	8	B4

FUNCTION TABLE (EACH TRANSCEIVER)

INP	UTS	SNxxLS243
GAB	GBA	SINXXL3243
L	L	A to B
Н	Н	B to A
н	L	Isolation
L	Н	Latch A and B (A = B)

DESCRIPTION

These four-data-line transceivers are designed for asynchronous two-way communications between data buses. SN74LS243 can be used to drive terminated lines down to 133Ω .

SN54LS243 is characterized for operation over the full military temperature range of -55°C to 125°C. SN74LS243 is characterized for operation from 0°C to 70°C.

SCHEMATICS OF INPUTS AND OUTPUTS

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

A

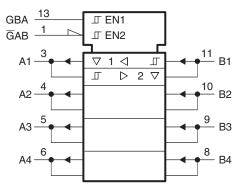
SN54LS243, SN74LS243



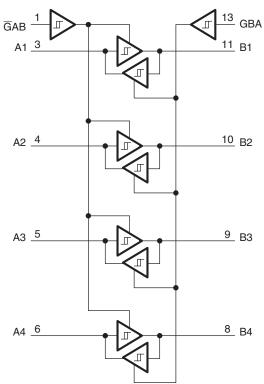
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LOGIC SYMBOL



A. These symbols are in accordance with ANSI/EEE Std. 91-1984 and IEC Publication 617-12.



LOGIC DIAGRAM (POSITIVE LOGIC)

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ABSOLUTE MAXIMUM RATINGS⁽¹⁾

			MIN	MAX	UNIT	
V _{CC}	Supply voltage ⁽²⁾		7	V		
V _{IN}	Input voltage		7	V		
	OFF-state output voltage		5.5	V		
-		SN54LS243	-55	125	**	
IA	Operating free-air temperature range	SN74LS243	0	70	°C	
T _{stg}	Storage temperature range	-65	150	°C		

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Voltage values are with respect to network ground terminal.

RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

		SN	54LS243	SN7	UNIT			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage ⁽¹⁾	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
I _{OH}	High-level output voltage			-12			-15	mA
I _{OL}	Low-level output voltage			12			24	mA
T _A	Operating free-air temperature	-55		125	0		70	°C

(1) Voltage values are with respect to network ground terminal.

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ELECTRICAL CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

DADAMETER		-	TEST CONDITIONS ⁽¹⁾			64LS243	SN74LS243				
	PARAMETER	1	EST CONDITIC	JNS ⁽¹⁾	MIN	TYP ⁽²⁾	MAX	MIN	TYP ⁽²⁾	MAX	UNIT
V _{IK}	A or B	$V_{CC} = MIN,$	I _I = -18 mA				-1.5			-1.5	V
Hyste	resis (V _{T+} – V _{T–})	$V_{CC} = MIN,$			0.2	0.4		0.2	0.4		V
V		V - MIN	V - 2 V	$V_{IL} = MAX,$ $I_{OH} = -3 mA$	2.4	3.1		2.4	3.1		V
V _{OH} V _{CC} = MIN,	v _{IH} = 2 v,	$V_{IL} = 0.5 V,$ $I_{OH} = MAX$	2			2					
V		$V_{CC} = MIN,$	$V_{IH} = 2 V$,	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	V
V_{OL} $V_{IL} = MAX$			I _{OL} = 24 mA					0.35	0.5	v	
I _{OZH}		$V_{CC} = MIN,$ $V_{IL} = MAX,$	V _{IH} = 2 V,	V _O = 2.7 V			40			40	μA
I _{OZL}		$V_{CC} = MIN,$ $V_{IL} = MAX,$	$V_{IH} = 2 V,$	V _O = 0.4 V			-200			-200	μA
	A or B			V _I = 5.5 V			0.1			0.1	A
I _I	GAB or GBA	$V_{CC} = MAX,$		V ₁ = 7 V			0.1			0.1	mA
I _{IH}		$V_{CC} = MAX,$					20			20	μΑ
	A inputs	V _{CC} = MAX, GAB and GB/					-0.2			-0.2	
I _{IL}	B inputs	V _{CC} = MAX, GAB and GB/					-0.2			-0.2	mA
	GAB or GBA	$V_{CC} = MAX,$	$V_{CC} = MAX, V_I = 0.4 V,$				-0.2			-0.2	
I _{OS}	I	V _{CC} = MAX	-		-40		-225	-40		-225	mA
	Outputs high					22	38		22	38	
I _{CC}	Outputs low	$V_{CC} = MAX,$	Outputs open,			29	50		29	50	mA
UU	All outputs disabled	(3)				32	54		32	54	

(1) For conditions shown as MIN or MAX, use the appropriate value specified under "recommended operating conditions."

(2) All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. (3) I_{CC} is measured with transceivers eabled in one direction only, or with all transceivers disabled.

SWITCHING CHARACTERISTICS

 $V_{CC} = 5 \text{ V}, \text{ } \text{T}_{A} = 25^{\circ}\text{C}$

PARAMETER	TEST CO	SN5		SN74LS243			UNIT		
PARAMETER	TEST CO	TEST CONDITIONS		TYP	MAX	MIN	TYP	MAX	UNIT
t _{PLH}				9	14		12	18	ns
t _{PHL}	$R_1 = 667 \Omega$,	C _L = 45 pF		12	18		12	18	ns
t _{PZL}	$R_{L} = 007 \Omega_{2},$			20	30		20	30	ns
t _{PZH}				15	23		15	23	ns
t _{PLZ}	$R_1 = 667 \Omega$,	C ₁ = 5 pF		10	20		10	20	ns
t _{PHZ}	$n_{\rm L}=007~\Omega_2,$	$O_L = 5 \text{ pr}$		15	25		15	25	ns

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
8002002CA	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8002002CA SNJ54LS243J
8002002DA	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8002002DA SNJ54LS243W
SN54LS243J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS243J
SN54LS243J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS243J
SN74LS243D	Obsolete	Production	SOIC (D) 14	-	-	Call TI	Call TI	0 to 70	LS243
SN74LS243DR	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS243
SN74LS243DR.A	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS243
SN74LS243N	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS243N
SN74LS243N.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS243N
SN74LS243NE4	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS243N
SNJ54LS243J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8002002CA SNJ54LS243J
SNJ54LS243J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8002002CA SNJ54LS243J
SNJ54LS243W	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8002002DA SNJ54LS243W
SNJ54LS243W.A	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8002002DA SNJ54LS243W

⁽¹⁾ **Status:** For more details on status, see our product life cycle.

(2) Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

10-Jun-2025

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF SN54LS243, SN74LS243 :

• Catalog : SN74LS243

Military : SN54LS243

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications



TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensio	ns are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS243DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

23-May-2025



*All dimensions are nominal

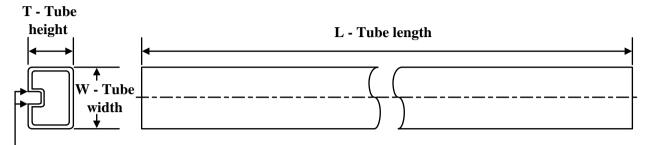
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS243DR	SOIC	D	14	2500	356.0	356.0	35.0

TEXAS INSTRUMENTS

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23-May-2025

TUBE



- B - Alignment groove width

*All dimensions	are nominal
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Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
8002002DA	W	CFP	14	25	506.98	26.16	6220	NA
SN74LS243N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS243N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS243N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS243N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS243NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS243NE4	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS243W	W	CFP	14	25	506.98	26.16	6220	NA
SNJ54LS243W.A	W	CFP	14	25	506.98	26.16	6220	NA

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14



GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



J0014A



PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



J0014A

EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



D0014A



PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



D0014A

EXAMPLE BOARD LAYOUT

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



D0014A

EXAMPLE STENCIL DESIGN

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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